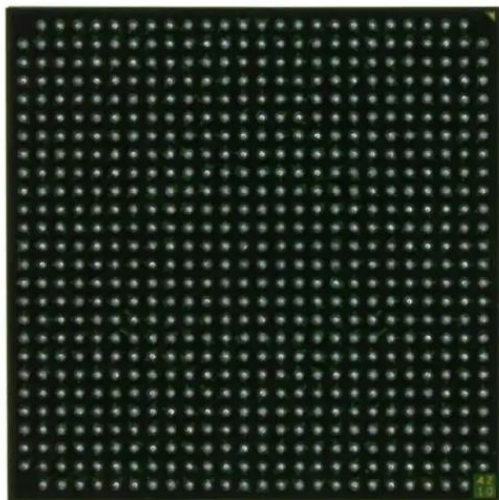




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	352
Number of Logic Elements/Cells	3168
Total RAM Bits	221184
Number of I/O	204
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FCBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp2-5ff672c

Functional Description: RocketIO X Multi-Gigabit Transceiver (MGT)

This section summarizes the features of the RocketIO X multi-gigabit transceiver. For an in-depth discussion of the RocketIO X MGT, including digital and analog design considerations, refer to the [RocketIO X Transceiver User Guide](#).

RocketIO X Overview

Either eight or twenty RocketIO X MGTs are available on the XC2VPX20 and XC2VPX70 devices, respectively. The XC2VPX20 MGT is designed to operate at any baud rate in the range of 2.488 Gb/s to 6.25 Gb/s per channel. This includes specific baud rates used by various standards as listed in [Table 1](#). The XC2VPX70 MGT operates at a fixed 4.25 Gb/s per channel.

The RocketIO X MGT consists of the *Physical Media Attachment* (PMA) and *Physical Coding Sublayer* (PCS). The PMA contains the 6.25 Gb/s serializer/deserializer (SERDES), TX/RX buffers, clock generator, and clock recovery circuitry. The RocketIO X PCS has been significantly updated relative to the RocketIO PCS. In addition to the existing RocketIO PCS features, the RocketIO X PCS features 64B/66B encoder/decoder/scrambler/descrambler and SONET compatibility.

See [Table 7, page 17](#), for a summary of the differences between the RocketIO X PMA/PCS and the RocketIO PMA/PCS.

[Figure 4, page 3](#) shows a high-level block diagram of the RocketIO X transceiver and its FPGA interface signals.

Table 1: Communications Standards Supported by RocketIO X Transceiver⁽²⁾

Mode	Channels (Lanes) ⁽¹⁾	I/O Bit Rate (Gb/s)
SONET OC-48	1	2.488
PCI Express	1, 2, 4, 8, 16	2.5
Infiniband	1, 4, 12	2.5
XAUI (10-Gb Ethernet)	4	3.125
XAUI (10-Gb Fibre Channel)	4	3.1875
Aurora (Xilinx protocol)	1, 2, 3, 4,...	2.488 to 6.25
Custom Mode	1, 2, 3, 4,...	2.488 to 6.25

Notes:

- One channel is considered to be one transceiver.
- XC2VPX70 operates at a fixed 4.25 Gb/s baud rate.

PMA

Transmitter Output

The RocketIO X transceiver is implemented in *Current Mode Logic* (CML). A CML transmitter output consists of transistors configured as shown in [Figure 2](#). CML uses a positive supply and offers easy interface requirements. In this configuration, both legs of the driver, VP and VN, sink current, with one leg always sinking more current than its complement. The CML output consists of a differential pair with 50Ω source resistors. The signal swing is created by switching the current in a common-source differential pair.

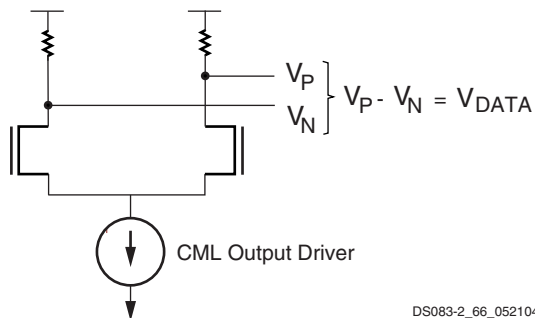


Figure 2: CML Output Configuration

Transmitter Termination

On-chip termination is provided at the transmitter, eliminating the need for external termination. The output driver and termination are powered by V_{TTX} at 1.5V. This configuration uses a CML approach with 50Ω termination to TXP and TXN as shown in [Figure 3](#).

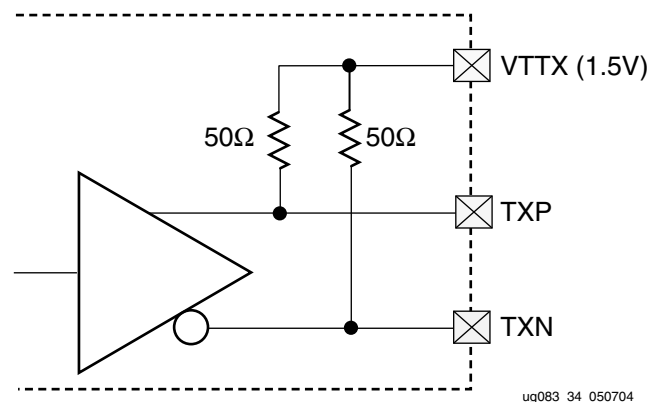


Figure 3: RocketIO X Transmit Termination

Table 12: Summary of Voltage Supply Requirements for All Input and Output Standards

I/O Standard	V _{CCO}		V _{REF}	Termination Type	
	Output	Input	Input	Output	Input
LVTTTL ⁽¹⁾	3.3	3.3	N/R	N/R	N/R
LVC MOS33 ⁽¹⁾			N/R	N/R	N/R
LVDCI_33 ⁽¹⁾			N/R	Series	N/R
PCIX ⁽²⁾			N/R	N/R	N/R
PCI33_3 ⁽²⁾			N/R	N/R	N/R
PCI66_3 ⁽²⁾			N/R	N/R	N/R
LVDS_25	2.5	Note (3)	N/R	N/R	N/R
LVDSEXT_25			N/R	N/R	N/R
LDT_25			N/R	N/R	N/R
ULVDS_25			N/R	N/R	N/R
BLVDS_25			N/R	N/R	N/R
LVPECL_25			N/R	N/R	N/R
SSTL2_I			1.25	N/R	N/R
SSTL2_II			1.25	N/R	N/R
LVC MOS25		2.5	N/R	N/R	N/R
LVDCI_25			N/R	Series	N/R
LVDCI_DV2_25			N/R	Series	N/R
LVDS_25_DCI			N/R	N/R	Split
LVDSEXT_25_DCI			N/R	N/R	Split
SSTL2_I_DCI			1.25	N/R	Split
SSTL2_II_DCI			1.25	Split	Split
LVDS_25_DT			N/R	N/R	N/R
LVDSEXT_25_DT			N/R	N/R	N/R
LDT_25_DT			N/R	N/R	N/R
ULVDS_25_DT			N/R	N/R	N/R

Table 12: Summary of Voltage Supply Requirements for All Input and Output Standards (Continued)

I/O Standard	V _{CCO}		V _{REF}	Termination Type	
	Output	Input	Input	Output	Input
HSTL_III_18	1.8	Note (3)	1.1	N/R	N/R
HSTL_IV_18			1.1	N/R	N/R
HSTL_I_18			0.9	N/R	N/R
HSTL_II_18			0.9	N/R	N/R
SSTL18_I			0.9	N/R	N/R
SSTL18_II			0.9	N/R	N/R
LVC MOS18		1.8	N/R	N/R	N/R
LVDCI_18			N/R	Series	N/R
LVDCI_DV2_18			N/R	Series	N/R
HSTL_III_DCI_18			1.1	N/R	Single
HSTL_IV_DCI_18			1.1	Single	Single
HSTL_I_DCI_18			0.9	N/R	Split
HSTL_II_DCI_18			0.9	Split	Split
SSTL18_I_DCI			0.9	N/R	Split
SSTL18_II_DCI			0.9	Split	Split
HSTL_III	1.5	Note (3)	0.9	N/R	N/R
HSTL_IV			0.9	N/R	N/R
HSTL_I			0.75	N/R	N/R
HSTL_II			0.75	N/R	N/R
LVC MOS15		1.5	N/R	N/R	N/R
LVDCI_15			N/R	Series	N/R
LVDCI_DV2_15			N/R	Series	N/R
GTL_P_DCI			1	Single	Single
HSTL_III_DCI			0.9	N/R	Single
HSTL_IV_DCI			0.9	Single	Single
HSTL_I_DCI			0.75	N/R	Split
HSTL_II_DCI			0.75	Split	Split
GTL_DCI	1.2	1.2	0.8	Single	Single
GTL_P	N/R	Note (3)	1	N/R	N/R
GTL			0.8	N/R	N/R

Notes:

1. See application note [XAPP659](#) for more detailed information.
2. See application note [XAPP653](#) for more detailed information.
3. Pin voltage must not exceed V_{CCO}.
4. N/R = no requirement.

Table 36: IOB Input Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-7	-6	-5	
HSLVDCI, 1.8V	HSLVDCI_18	T _{IHSLVDCI_18}	0.59	0.68	0.75	ns
HSLVDCI, 2.5V	HSLVDCI_25	T _{IHSLVDCI_25}	0.59	0.68	0.75	ns
HSLVDCI, 3.3V	HSLVDCI_33	T _{IHSLVDCI_33}	0.59	0.68	0.75	ns
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	T _{IGTL_DCI}	0.49	0.57	0.62	ns
GTL Plus with DCI	GTLP_DCI	T _{IGTLP_DCI}	0.27	0.31	0.35	ns
HSTL (High-Speed Transceiver Logic), Class I, with DCI	HSTL_I_DCI	T _{IHSTL_I_DCI}	0.27	0.31	0.35	ns
HSTL, Class II, with DCI	HSTL_II_DCI	T _{IHSTL_II_DCI}	0.27	0.31	0.35	ns
HSTL, Class III, with DCI	HSTL_III_DCI	T _{IHSTL_III_DCI}	0.27	0.31	0.35	ns
HSTL, Class IV, with DCI	HSTL_IV_DCI	T _{IHSTL_IV_DCI}	0.27	0.31	0.35	ns
HSTL, Class I, 1.8V, with DCI	HSTL_I_DCI_18	T _{IHSTL_I_DCI_18}	0.27	0.31	0.35	ns
HSTL, Class II, 1.8V, with DCI	HSTL_II_DCI_18	T _{IHSTL_II_DCI_18}	0.27	0.31	0.35	ns
HSTL, Class III, 1.8V, with DCI	HSTL_III_DCI_18	T _{IHSTL_III_DCI_18}	0.27	0.31	0.35	ns
HSTL, Class IV, 1.8V, with DCI	HSTL_IV_DCI_18	T _{IHSTL_IV_DCI_18}	0.27	0.31	0.35	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI	SSTL18_I_DCI	T _{ISSTL18_I_DCI}	0.62	0.72	0.79	ns
SSTL, Class II, 1.8V, with DCI	SSTL18_II_DCI	T _{ISSTL18_II_DCI}	0.64	0.73	0.81	ns
SSTL, Class I, 2.5V, with DCI	SSTL2_I_DCI	T _{ISSTL2_I_DCI}	0.17	0.20	0.22	ns
SSTL, Class II, 2.5V, with DCI	SSTL2_II_DCI	T _{ISSTL2_II_DCI}	0.17	0.20	0.22	ns
LVDS, 2.5V, with DCI	LVDS_25_DCI	T _{ILVDS_25_DCI}	0.31	0.36	0.40	ns
LVDSEXT, 2.5V, with DCI	LVDSEXT_25_DCI	T _{ILVDSEXT_25_DCI}	0.33	0.37	0.41	ns
LVDS, 2.5V, with Differential Termination (DT)	LVDS_25_DT	T _{ILVDS_25_DT}	0.31	0.36	0.40	ns
LVDSEXT, 2.5V, with DT	LVDSEXT_25_DT	T _{ILVDSEXT_25_DT}	0.33	0.37	0.41	ns
ULVDS, 2.5V, with DT	ULVDS_25_DT	T _{IULVDS_25_DT}	0.31	0.36	0.40	ns
LDT, 2.5V, with DT	LDT_25_DT	T _{ILD_25_DT}	0.31	0.36	0.40	ns

IOB Output Switching Characteristics Standard Adjustments

Table 38 gives all standard-specific adjustments for output delays terminating at pads, based on standard capacitive load, C_{REF} . Output delays terminating at a pad are specified for LVCMOS25 with 12 mA drive and fast slew rate. For other standards, adjust the delays by the values shown.

Table 38: IOB Output Switching Characteristics Standard Adjustments

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-7	-6	-5	
LVTTTL (Low-Voltage Transistor-Transistor Logic), Slow, 2 mA	LVTTTL_S2	$T_{OLVTTTL_S2}$	5.42	6.24	6.86	ns
LVTTTL, Slow, 4 mA	LVTTTL_S4	$T_{OLVTTTL_S4}$	3.09	3.55	3.91	ns
LVTTTL, Slow, 6 mA	LVTTTL_S6	$T_{OLVTTTL_S6}$	2.26	2.60	2.86	ns
LVTTTL, Slow, 8 mA	LVTTTL_S8	$T_{OLVTTTL_S8}$	1.47	1.69	1.86	ns
LVTTTL, Slow, 12 mA	LVTTTL_S12	$T_{OLVTTTL_S12}$	1.02	1.18	1.29	ns
LVTTTL, Slow, 16 mA	LVTTTL_S16	$T_{OLVTTTL_S16}$	0.46	0.53	0.58	ns
LVTTTL, Slow, 24 mA	LVTTTL_S24	$T_{OLVTTTL_S24}$	0.37	0.42	0.47	ns
LVTTTL, Fast, 2 mA	LVTTTL_F2	$T_{OLVTTTL_F2}$	4.42	5.09	5.59	ns
LVTTTL, Fast, 4 mA	LVTTTL_F4	$T_{OLVTTTL_F4}$	1.95	2.24	2.46	ns
LVTTTL, Fast, 6 mA	LVTTTL_F6	$T_{OLVTTTL_F6}$	1.10	1.26	1.39	ns
LVTTTL, Fast, 8 mA	LVTTTL_F8	$T_{OLVTTTL_F8}$	0.40	0.46	0.51	ns
LVTTTL, Fast, 12 mA	LVTTTL_F12	$T_{OLVTTTL_F12}$	0.24	0.27	0.30	ns
LVTTTL, Fast, 16 mA	LVTTTL_F16	$T_{OLVTTTL_F16}$	0.05	0.06	0.07	ns
LVTTTL, Fast, 24 mA	LVTTTL_F24	$T_{OLVTTTL_F24}$	-0.01	-0.01	-0.01	ns
LVC MOS (Low-Voltage CMOS), 3.3V, Slow, 2 mA	LVC MOS33_S2	$T_{OLVCMOS33_S2}$	5.42	6.23	6.86	ns
LVC MOS, 3.3V, Slow, 4 mA	LVC MOS33_S4	$T_{OLVCMOS33_S4}$	3.14	3.61	3.97	ns
LVC MOS, 3.3V, Slow, 6 mA	LVC MOS33_S6	$T_{OLVCMOS33_S6}$	2.26	2.60	2.86	ns
LVC MOS, 3.3V, Slow, 8 mA	LVC MOS33_S8	$T_{OLVCMOS33_S8}$	1.47	1.69	1.86	ns
LVC MOS, 3.3V, Slow, 12 mA	LVC MOS33_S12	$T_{OLVCMOS33_S12}$	1.03	1.18	1.30	ns
LVC MOS, 3.3V, Slow, 16 mA	LVC MOS33_S16	$T_{OLVCMOS33_S16}$	0.45	0.52	0.57	ns
LVC MOS, 3.3V, Slow, 24 mA	LVC MOS33_S24	$T_{OLVCMOS33_S24}$	0.39	0.44	0.49	ns
LVC MOS, 3.3V, Fast, 2 mA	LVC MOS33_F2	$T_{OLVCMOS33_F2}$	4.46	5.13	5.64	ns
LVC MOS, 3.3V, Fast, 4 mA	LVC MOS33_F4	$T_{OLVCMOS33_F4}$	1.96	2.25	2.48	ns
LVC MOS, 3.3V, Fast, 6 mA	LVC MOS33_F6	$T_{OLVCMOS33_F6}$	1.11	1.28	1.40	ns
LVC MOS, 3.3V, Fast, 8 mA	LVC MOS33_F8	$T_{OLVCMOS33_F8}$	0.41	0.47	0.52	ns
LVC MOS, 3.3V, Fast, 12 mA	LVC MOS33_F12	$T_{OLVCMOS33_F12}$	0.23	0.26	0.28	ns
LVC MOS, 3.3V, Fast, 16 mA	LVC MOS33_F16	$T_{OLVCMOS33_F16}$	0.02	0.02	0.03	ns
LVC MOS, 3.3V, Fast, 24 mA	LVC MOS33_F24	$T_{OLVCMOS33_F24}$	-0.07	-0.08	-0.09	ns
LVC MOS, 2.5V, Slow, 2 mA	LVC MOS25_S2	$T_{OLVCMOS25_S2}$	4.12	4.74	5.21	ns
LVC MOS, 2.5V, Slow, 4 mA	LVC MOS25_S4	$T_{OLVCMOS25_S4}$	2.43	2.80	3.07	ns
LVC MOS, 2.5V, Slow, 6 mA	LVC MOS25_S6	$T_{OLVCMOS25_S6}$	1.76	2.02	2.22	ns
LVC MOS, 2.5V, Slow, 8 mA	LVC MOS25_S8	$T_{OLVCMOS25_S8}$	1.04	1.19	1.31	ns
LVC MOS, 2.5V, Slow, 12 mA	LVC MOS25_S12	$T_{OLVCMOS25_S12}$	0.76	0.87	0.96	ns
LVC MOS, 2.5V, Slow, 16 mA	LVC MOS25_S16	$T_{OLVCMOS25_S16}$	0.41	0.47	0.52	ns
LVC MOS, 2.5V, Slow, 24 mA	LVC MOS25_S24	$T_{OLVCMOS25_S24}$	0.23	0.26	0.28	ns
LVC MOS, 2.5V, Fast, 2 mA	LVC MOS25_F2	$T_{OLVCMOS25_F2}$	3.29	3.78	4.16	ns
LVC MOS, 2.5V, Fast, 4 mA	LVC MOS25_F4	$T_{OLVCMOS25_F4}$	1.31	1.50	1.65	ns

Input Clock Tolerances

Table 58: Input Clock Tolerances

Description	Symbol	Constraints F _{CLKIN}	Speed Grade						Units
			−7		−6		−5		
			Min	Max	Min	Max	Min	Max	
Input Clock Low/High Pulse Width									
PSCLK	PSCLK_PULSE	< 1MHz	25.00		25.00		25.00		ns
PSCLK and CLKIN ⁽³⁾	PSCLK_PULSE and CLKIN_PULSE	1 – 10 MHz	25.00		25.00		25.00		ns
		10 – 25 MHz	10.00		10.00		10.00		ns
		25 – 50 MHz	5.00		5.00		5.00		ns
		50 – 100 MHz	3.00		3.00		3.00		ns
		100 – 150 MHz	2.40		2.40		2.40		ns
		150 – 200 MHz	2.00		2.00		2.00		ns
		200 – 250 MHz	1.80		1.80		1.80		ns
		250 – 300 MHz	1.50		1.50		1.50		ns
		300 – 350 MHz	1.30		1.30		1.30		ns
		350 – 400 MHz	1.15		1.15		1.15		ns
> 400 MHz	1.05		1.05		1.05		ns		
Input Clock Cycle-Cycle Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_LF			±300		±300		±300	ps
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_LF			±300		±300		±300	ps
Input Clock Cycle-Cycle Jitter (High Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_HF			±150		±150		±150	ps
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_HF			±150		±150		±150	ps
Input Clock Period Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_LF			±1		±1		±1	ns
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_LF			±1		±1		±1	ns
Input Clock Period Jitter (High Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_HF			±1		±1		±1	ns
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_HF			±1		±1		±1	ns
Feedback Clock Path Delay Variation									
CLKFB off-chip feedback	CLKFB_DELAY_VAR_EXT			±1		±1		±1	ns

Notes:

1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. If both DLL and CLKFX outputs are used, follow the more restrictive specification.
3. If DCM phase shift feature is used and CLKIN frequency > 200 Mhz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

Miscellaneous Timing Parameters

Table 61: Miscellaneous Timing Parameters

			Speed Grade			
Description	Symbol	Constraints F _{CLKIN}	-7	-6	-5	Units
Time Required to Achieve LOCK						
Using DLL outputs ⁽¹⁾	LOCK_DLL:					
	LOCK_DLL_60	> 60MHz	20.00	20.00	20.00	us
	LOCK_DLL_50_60	50 - 60 MHz	25.00	25.00	25.00	us
	LOCK_DLL_40_50	40 - 50 MHz	50.00	50.00	50.00	us
	LOCK_DLL_30_40	30 - 40 MHz	90.00	90.00	90.00	us
	LOCK_DLL_24_30	24 - 30 MHz	120.00	120.00	120.00	us
Using CLKFX outputs	LOCK_FX_MIN		10.00	10.00	10.00	ms
	LOCK_FX_MAX		10.00	10.00	10.00	ms
Additional lock time with fine phase shifting	LOCK_DLL_FINE_SHIFT		50.00	50.00	50.00	us
Fine Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.00	10.00	10.00	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.00	30.00	30.00	ps
	DCM_TAP_MAX		50.00	50.00	50.00	ps

Notes:

1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.

Frequency Synthesis

Table 62: Frequency Synthesis

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross-Reference

Table 63: Parameter Cross-Reference

Libraries Guide	Data Sheet
DLL_CLKOUT_{MINIMAX}_LF	CLKOUT_FREQ_{1X 2X DV}_LF
DFS_CLKOUT_{MINIMAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MINIMAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MINIMAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MINIMAX}_HF	CLKOUT_FREQ_{1X DV}_HF
DFS_CLKOUT_{MINIMAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MINIMAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MINIMAX}_HF	CLKIN_FREQ_FX_HF



Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Pinout Information

DS083 (v5.0) June 21, 2011

Product Specification

This document provides Virtex™-II Pro Device/Package Combinations, Maximum I/Os, and Virtex-II Pro Pin Definitions, followed by pinout tables, for these packages:

- FG256/FGG256 Fine-Pitch BGA Package
- FG456/FGG456 Fine-Pitch BGA Package
- FG676/FGG676 Fine-Pitch BGA Package
- FF672 Flip-Chip Fine-Pitch BGA Package
- FF896 Flip-Chip Fine-Pitch BGA Package

- FF1152 Flip-Chip Fine-Pitch BGA Package
- FF1148 Flip-Chip Fine-Pitch BGA Package
- FF1517 Flip-Chip Fine-Pitch BGA Package
- FF1704 Flip-Chip Fine-Pitch BGA Package
- FF1696 Flip-Chip Fine-Pitch BGA Package

For device pinout diagrams and layout guidelines, refer to the [Virtex-II Pro Platform FPGA User Guide](#). ASCII package pinout files are also available for download from the Xilinx website (www.xilinx.com).

Virtex-II Pro Device/Package Combinations and Maximum I/Os⁽¹⁾

Wire-bond and flip-chip packages are available. [Table 1](#) and [Table 2](#) show the maximum number of user I/Os possible in wire-bond and flip-chip packages, respectively.

- FG denotes wire-bond fine-pitch BGA (1.00 mm pitch).
- FGG denotes Pb-free wire-bond fine-pitch BGA (1.00 mm pitch).
- FF denotes flip-chip fine-pitch BGA (1.00 mm pitch)

Table 1: Wire-Bond Packages Information

Package ⁽¹⁾	FG256/ FGG256	FG456/ FGG456	FG676/ FGG676
Pitch (mm)	1.00	1.00	1.00
Size (mm)	17 x 17	23 x 23	26 x 26
Maximum I/Os	140	248	412

Notes:

1. Wire-bond packages include FGGnnn Pb-free versions. See [Virtex-II Pro Ordering Examples \(Module 1\)](#).

Table 2: Flip-Chip Packages Information

Package	FF672	FF896	FF1152	FF1148	FF1517	FF1704	FF1696
Pitch (mm)	1.00	1.00	1.00	1.00	1.00	1.00	1.00
Size (mm)	27 x 27	31 x 31	35 x 35	35 x 35	40 x 40	42.5 x 42.5	42.5 x 42.5
Maximum I/Os	396	556	644	812	964	1040	1200

[Table 3](#) shows the number of available I/Os, the number of RocketIO™ (or RocketIO X) multi-gigabit transceiver (MGT) pins, and the number of differential I/O pairs for each Virtex-II Pro device/package combination. The number of I/Os per package includes all user I/Os *except* the fifteen control pins (CCLK, DONE, M0, M1, M2, PROG_B, PWRDWN_B, TCK, TDI, TDO, TMS, HSWAP_EN, DXN, DXP, and RSVD), the nine (per transceiver) RocketIO MGT pins (TXP, TXN, RXP, RXN, AVCCAUTX, AVCCAUXRX, VTTX, VTRX, and GNDA), and for Virtex-II Pro X devices only, the two BREFCLKN/BREFCLKP differential clock input pairs (four pins). The Virtex-II Pro X devices are highlighted in bold type.

1. Unless otherwise noted, "Virtex-II Pro" refers to members of the Virtex-II Pro and/or Virtex-II Pro X families.

Table 3: Virtex-II Pro Available I/Os and RocketIO MGT Pins per Device/Package Combination

Virtex-II Pro Device	User I/Os & RocketIO MGT Pins	Virtex-II Pro Package ⁽¹⁾									
		FG256/ FGG256	FG456/ FGG456	FG676/ FGG456	FF672	FF896	FF1152	FF1148	FF1517	FF1704	FF1696
XC2VP2	Available User I/Os	140	156	-	204	-	-	-	-	-	-
	RocketIO MGT Pins	36	36	-	36	-	-	-	-	-	-
	Differential I/O Pairs	68	76	-	100	-	-	-	-	-	-
XC2VP4	Available User I/Os	140	248	-	348	-	-	-	-	-	-
	RocketIO MGT Pins	36	36	-	36	-	-	-	-	-	-
	Differential I/O Pairs	68	122	-	172	-	-	-	-	-	-
XC2VP7	Available User I/Os	-	248	-	396	396	-	-	-	-	-
	RocketIO MGT Pins	-	72	-	72	72	-	-	-	-	-
	Differential I/O Pairs	-	122	-	196	196	-	-	-	-	-
XC2VP20	Available User I/Os	-	-	404	-	556	564	-	-	-	-
	RocketIO MGT Pins	-	-	72	-	72	72	-	-	-	-
	Differential I/O Pairs	-	-	196	-	272	276	-	-	-	-
XC2VPX20	Available User I/Os	-	-	-	-	552	-	-	-	-	-
	RocketIO X MGT Pins	-	-	-	-	72	-	-	-	-	-
	Differential I/O Pairs	-	-	-	-	270	-	-	-	-	-
XC2VP30	Available User I/Os	-	-	416	-	556	644	-	-	-	-
	RocketIO MGT Pins	-	-	72	-	72	72	-	-	-	-
	Differential I/O Pairs	-	-	202	-	272	316	-	-	-	-
XC2VP40	Available User I/Os	-	-	416	-	-	692	804	-	-	-
	RocketIO MGT Pins	-	-	72	-	-	108	0	-	-	-
	Differential I/O Pairs	-	-	202	-	-	340	396	-	-	-
XC2VP50	Available User I/Os	-	-	-	-	-	692	812	852	-	-
	RocketIO MGT Pins	-	-	-	-	-	144	0	144	-	-
	Differential I/O Pairs	-	-	-	-	-	340	400	420	-	-

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
N/A	GND	R15
N/A	GND	L6
N/A	GND	L11
N/A	GND	K9
N/A	GND	K8
N/A	GND	K7
N/A	GND	K10
N/A	GND	J9
N/A	GND	J8
N/A	GND	J7
N/A	GND	J10
N/A	GND	H9
N/A	GND	H8
N/A	GND	H7
N/A	GND	H10
N/A	GND	G9
N/A	GND	G8
N/A	GND	G7
N/A	GND	G10
N/A	GND	F6
N/A	GND	F11
N/A	GND	B2
N/A	GND	B15
N/A	GND	A16
N/A	GND	A1

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
N/A	RSVD	C23			
N/A	VBATT	A24			
N/A	TMS	B24			
N/A	TCK	B26			
N/A	TDO	D24			
N/A	CCLK	AE24			
N/A	PWRDWN_B	AF24			
N/A	DONE	AD23			
N/A	AVCCAUXRX16	AE23			
N/A	VTRXPAD16	AE22			
N/A	RXNPAD16	AF23			
N/A	RXPPAD16	AF22			
N/A	GNDA16	AD21			
N/A	TXPPAD16	AF21			
N/A	TXNPAD16	AF20			
N/A	VTTXPAD16	AE20			
N/A	AVCCAUTX16	AE21			
N/A	AVCCAUXRX18	AE18			
N/A	VTRXPAD18	AE17			
N/A	RXNPAD18	AF18			
N/A	RXPPAD18	AF17			
N/A	GNDA18	AD16			
N/A	TXPPAD18	AF16			
N/A	TXNPAD18	AF15			
N/A	VTTXPAD18	AE15			
N/A	AVCCAUTX18	AE16			
N/A	AVCCAUXRX19	AE12			
N/A	VTRXPAD19	AE11			
N/A	RXNPAD19	AF12			
N/A	RXPPAD19	AF11			
N/A	GNDA19	AD11			
N/A	TXPPAD19	AF10			
N/A	TXNPAD19	AF9			
N/A	VTTXPAD19	AE9			
N/A	AVCCAUTX19	AE10			

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	IO_L18N_7	L25	NC			
7	IO_L17P_7	F34	NC			
7	IO_L17N_7	F33	NC			
7	IO_L16P_7	G30	NC			
7	IO_L16N_7/VREF_7	G29	NC			
7	IO_L15P_7	G32	NC			
7	IO_L15N_7	G31	NC			
7	IO_L06P_7	F31				
7	IO_L06N_7	F30				
7	IO_L05P_7	J28				
7	IO_L05N_7	J27				
7	IO_L04P_7	E34				
7	IO_L04N_7/VREF_7	E33				
7	IO_L03P_7	E32				
7	IO_L03N_7	E31				
7	IO_L02P_7	F28				
7	IO_L02N_7	F27				
7	IO_L01P_7/VRN_7	D34				
7	IO_L01N_7/VRP_7	D33				
0	VCCO_0	C29				
0	VCCO_0	E20				
0	VCCO_0	F25				
0	VCCO_0	L20				
0	VCCO_0	L21				
0	VCCO_0	L22				
0	VCCO_0	L23				
0	VCCO_0	M18				
0	VCCO_0	M19				
0	VCCO_0	M20				
0	VCCO_0	M21				
0	VCCO_0	M22				
1	VCCO_1	C6				
1	VCCO_1	E15				
1	VCCO_1	F10				
1	VCCO_1	L12				
1	VCCO_1	L13				
1	VCCO_1	L14				

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
7	VCCO_7	U23		
7	VCCO_7	T23		
7	VCCO_7	R23		
7	VCCO_7	P23		
7	VCCO_7	N23		
6	VCCO_6	AK33		
6	VCCO_6	AM31		
6	VCCO_6	AH31		
6	VCCO_6	AD31		
6	VCCO_6	Y31		
6	VCCO_6	AM27		
6	VCCO_6	AH27		
6	VCCO_6	AD27		
6	VCCO_6	Y27		
6	VCCO_6	AF26		
6	VCCO_6	AC24		
6	VCCO_6	AB23		
6	VCCO_6	AA23		
6	VCCO_6	Y23		
6	VCCO_6	W23		
6	VCCO_6	V23		
5	VCCO_5	AL24		
5	VCCO_5	AG24		
5	VCCO_5	AD23		
5	VCCO_5	AC22		
5	VCCO_5	AC21		
5	VCCO_5	AL20		
5	VCCO_5	AG20		
5	VCCO_5	AC20		
5	VCCO_5	AC19		
5	VCCO_5	AC18		
4	VCCO_4	AC17		
4	VCCO_4	AC16		
4	VCCO_4	AL15		
4	VCCO_4	AG15		
4	VCCO_4	AC15		
4	VCCO_4	AC14		
4	VCCO_4	AC13		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
5	IO_L57N_5/VREF_5	AT23		
5	IO_L57P_5	AU23		
5	IO_L56N_5	AJ22		
5	IO_L56P_5	AK22		
5	IO_L55N_5	AN23		
5	IO_L55P_5	AP24		
5	IO_L54N_5	AL23		
5	IO_L54P_5	AM23		
5	IO_L53_5/No_Pair	AH23		
5	IO_L50_5/No_Pair	AG23		
5	IO_L49N_5	AR24		
5	IO_L49P_5	AR25		
5	IO_L48N_5	AL24		
5	IO_L48P_5	AM24		
5	IO_L47N_5	AH22		
5	IO_L47P_5	AJ23		
5	IO_L46N_5	AT25		
5	IO_L46P_5	AU25		
5	IO_L45N_5/VREF_5	AN25		
5	IO_L45P_5	AP25		
5	IO_L44N_5	AH24		
5	IO_L44P_5	AH25		
5	IO_L43N_5	AL25		
5	IO_L43P_5	AM25		
5	IO_L39N_5	AT26		
5	IO_L39P_5	AU26		
5	IO_L38N_5	AK24		
5	IO_L38P_5	AK25		
5	IO_L37N_5	AP26		
5	IO_L37P_5	AR26		
5	IO_L36N_5/VREF_5	AM26	NC	
5	IO_L36P_5	AN26	NC	
5	IO_L35N_5	AJ25	NC	
5	IO_L35P_5	AJ26	NC	
5	IO_L34N_5	AR27	NC	
5	IO_L34P_5	AT27	NC	
5	IO_L30N_5	AN27	NC	
5	IO_L30P_5	AP28	NC	

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
7	IO_L24N_7	L37		
7	IO_L23P_7	P31		
7	IO_L23N_7	P32		
7	IO_L22P_7	L34		
7	IO_L22N_7/VREF_7	L35		
7	IO_L21P_7	L32		
7	IO_L21N_7	L33		
7	IO_L20P_7	N29		
7	IO_L20N_7	M29		
7	IO_L19P_7	K38		
7	IO_L19N_7	K39		
7	IO_L18P_7	J37		
7	IO_L18N_7	K37		
7	IO_L17P_7	N30		
7	IO_L17N_7	P30		
7	IO_L16P_7	K35		
7	IO_L16N_7/VREF_7	K36		
7	IO_L15P_7	K34		
7	IO_L15N_7	K33		
7	IO_L14P_7	N31		
7	IO_L14N_7	M32		
7	IO_L13P_7	J38		
7	IO_L13N_7	J39		
7	IO_L12P_7	J35		
7	IO_L12N_7	H36		
7	IO_L11P_7	M30		
7	IO_L11N_7	L31		
7	IO_L10P_7	J33		
7	IO_L10N_7/VREF_7	J34		
7	IO_L09P_7	H37		
7	IO_L09N_7	H38		
7	IO_L08P_7	K31		
7	IO_L08N_7	K32		
7	IO_L07P_7	H33		
7	IO_L07N_7	H34		
7	IO_L84P_7	G38	NC	
7	IO_L84N_7	G39	NC	
7	IO_L82P_7	G36	NC	

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
2	VCCO_2	F8		
2	VCCO_2	U7		
2	VCCO_2	Y5		
2	VCCO_2	N4		
2	VCCO_2	J4		
2	VCCO_2	E4		
2	VCCO_2	U3		
2	VCCO_2	E1		
1	VCCO_1	N14		
1	VCCO_1	K13		
1	VCCO_1	F13		
1	VCCO_1	P19		
1	VCCO_1	P18		
1	VCCO_1	P17		
1	VCCO_1	K17		
1	VCCO_1	F17		
1	VCCO_1	P16		
1	VCCO_1	N16		
1	VCCO_1	P15		
1	VCCO_1	N15		
0	VCCO_0	K27		
0	VCCO_0	F27		
0	VCCO_0	N26		
0	VCCO_0	P25		
0	VCCO_0	N25		
0	VCCO_0	P24		
0	VCCO_0	N24		
0	VCCO_0	P23		
0	VCCO_0	K23		
0	VCCO_0	F23		
0	VCCO_0	P22		
0	VCCO_0	P21		
N/A	CCLK	AJ10		
N/A	PROG_B	D32		
N/A	DONE	AJ11		
N/A	M0	AP31		
N/A	M1	AJ30		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L09P_7		K36		
7	IO_L09N_7		K35		
7	IO_L08P_7		K38		
7	IO_L08N_7		K37		
7	IO_L07P_7		L33		
7	IO_L07N_7		K34		
7	IO_L84P_7		J41		
7	IO_L84N_7		J42		
7	IO_L83P_7		J39		
7	IO_L83N_7		J38		
7	IO_L82P_7		J36		
7	IO_L82N_7/VREF_7		J37		
7	IO_L81P_7		J35		
7	IO_L81N_7		H36		
7	IO_L80P_7		H41		
7	IO_L80N_7		H40		
7	IO_L79P_7		H38		
7	IO_L79N_7		H39		
7	IO_L78P_7		H37		
7	IO_L78N_7		G38		
7	IO_L77P_7		G42		
7	IO_L77N_7		G41		
7	IO_L76P_7		G39		
7	IO_L76N_7/VREF_7		G40		
7	IO_L75P_7		F41		
7	IO_L75N_7		F42		
7	IO_L74P_7		F40		
7	IO_L74N_7		F39		
7	IO_L73P_7		E41		
7	IO_L73N_7		E42		
7	IO_L06P_7		D41		
7	IO_L06N_7		D42		
7	IO_L05P_7		E40		
7	IO_L05N_7		D40		
7	IO_L04P_7		F36		
7	IO_L04N_7/VREF_7		G37		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	VCCINT		AF16		
N/A	VCCINT		AG27		
N/A	VCCINT		AG26		
N/A	VCCINT		AG25		
N/A	VCCINT		AG24		
N/A	VCCINT		AG23		
N/A	VCCINT		AG22		
N/A	VCCINT		AG21		
N/A	VCCINT		AG20		
N/A	VCCINT		AG19		
N/A	VCCINT		AG18		
N/A	VCCINT		AG17		
N/A	VCCINT		AG16		
N/A	VCCINT		AH28		
N/A	VCCINT		AH27		
N/A	VCCINT		AH26		
N/A	VCCINT		AH17		
N/A	VCCINT		AH16		
N/A	VCCINT		AH15		
N/A	VCCINT		AJ29		
N/A	VCCINT		AJ28		
N/A	VCCINT		AJ27		
N/A	VCCINT		AJ16		
N/A	VCCINT		AJ15		
N/A	VCCINT		AJ14		
N/A	VCCINT		AK30		
N/A	VCCINT		AK13		
N/A	VCCINT		AA27		
N/A	VCCINT		AA16		
N/A	VCCINT		Y27		
N/A	VCCINT		Y16		
N/A	VCCINT		W27		
N/A	VCCINT		W16		
N/A	VCCINT		V27		
N/A	VCCINT		V16		
N/A	VCCINT		U27		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
4	IO_L26P_4	AU12	
4	IO_L27N_4	AR12	
4	IO_L27P_4/VREF_4	AP12	
4	IO_L28N_4	AW13	
4	IO_L28P_4	AW12	
4	IO_L29N_4	BA12	
4	IO_L29P_4	AY12	
4	IO_L30N_4	AN13	
4	IO_L30P_4	AM13	
4	IO_L34N_4	AU13	
4	IO_L34P_4	AT13	
4	IO_L35N_4	BA13	
4	IO_L35P_4	AY13	
4	IO_L36N_4	AM14	
4	IO_L36P_4/VREF_4	AL14	
4	IO_L76N_4	AR15	
4	IO_L76P_4	AT14	
4	IO_L77N_4	AV14	
4	IO_L77P_4	AU14	
4	IO_L78N_4	AP14	
4	IO_L78P_4	AN14	
4	IO_L79N_4	AW15	
4	IO_L79P_4	AY14	
4	IO_L80_4/No_Pair	BB14	
4	IO_L83_4/No_Pair	BA14	
4	IO_L84N_4	AM15	
4	IO_L84P_4	AL15	
4	IO_L85N_4	AT16	
4	IO_L85P_4	AT15	
4	IO_L86N_4	AV15	
4	IO_L86P_4	AU15	
4	IO_L87N_4	AP15	
4	IO_L87P_4/VREF_4	AN15	
4	IO_L37N_4	AY16	
4	IO_L37P_4	AY15	
4	IO_L38N_4	BB15	
4	IO_L38P_4	BA15	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
5	IO_L10N_5	AW27	NC
5	IO_L10P_5	AW26	NC
5	IO_L45N_5/VREF_5	AN27	
5	IO_L45P_5	AP27	
5	IO_L44N_5	AU27	
5	IO_L44P_5	AV27	
5	IO_L43N_5	AR27	
5	IO_L43P_5	AR26	
5	IO_L39N_5	AL27	
5	IO_L39P_5	AM27	
5	IO_L38N_5	BA28	
5	IO_L38P_5	BB28	
5	IO_L37N_5	AY28	
5	IO_L37P_5	AY27	
5	IO_L87N_5/VREF_5	AN28	
5	IO_L87P_5	AP28	
5	IO_L86N_5	AU28	
5	IO_L86P_5	AV28	
5	IO_L85N_5	AT28	
5	IO_L85P_5	AT27	
5	IO_L84N_5	AL28	
5	IO_L84P_5	AM28	
5	IO_L83_5/No_Pair	BA29	
5	IO_L80_5/No_Pair	BB29	
5	IO_L79N_5	AY29	
5	IO_L79P_5	AW28	
5	IO_L78N_5	AN29	
5	IO_L78P_5	AP29	
5	IO_L77N_5	AU29	
5	IO_L77P_5	AV29	
5	IO_L76N_5	AT29	
5	IO_L76P_5	AR28	
5	IO_L36N_5/VREF_5	AL29	
5	IO_L36P_5	AM29	
5	IO_L35N_5	AY30	
5	IO_L35P_5	BA30	
5	IO_L34N_5	AT30	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
7	IO_L79P_7	D41	
7	IO_L79N_7	D42	
7	IO_L78P_7	C39	
7	IO_L78N_7	C40	
7	IO_L77P_7	H34	
7	IO_L77N_7	H35	
7	IO_L76P_7	C37	
7	IO_L76N_7/VREF_7	D36	
7	IO_L75P_7	B38	
7	IO_L75N_7	C38	
7	IO_L74P_7	F34	
7	IO_L74N_7	G34	
7	IO_L73P_7	C35	
7	IO_L73N_7	C36	
7	IO_L06P_7	A39	
7	IO_L06N_7	B39	
7	IO_L05P_7	D34	
7	IO_L05N_7	D35	
7	IO_L04P_7	A37	
7	IO_L04N_7/VREF_7	B37	
7	IO_L03P_7	A36	
7	IO_L03N_7	B36	
7	IO_L02P_7	B34	
7	IO_L02N_7	C34	
7	IO_L01P_7/VRN_7	A35	
7	IO_L01N_7/VRP_7	B35	
7	VCCO_7	W39	
7	VCCO_7	P39	
7	VCCO_7	K39	
7	VCCO_7	F39	
7	VCCO_7	D37	
7	VCCO_7	W35	
7	VCCO_7	P35	
7	VCCO_7	K35	
7	VCCO_7	M33	
7	VCCO_7	H33	